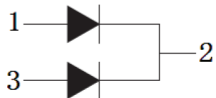


/ Descriptions

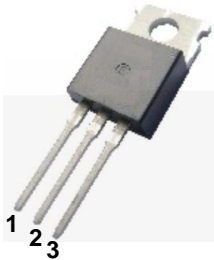
/ Features

/ Applications

/ Equivalent Circuit



/ Pinning

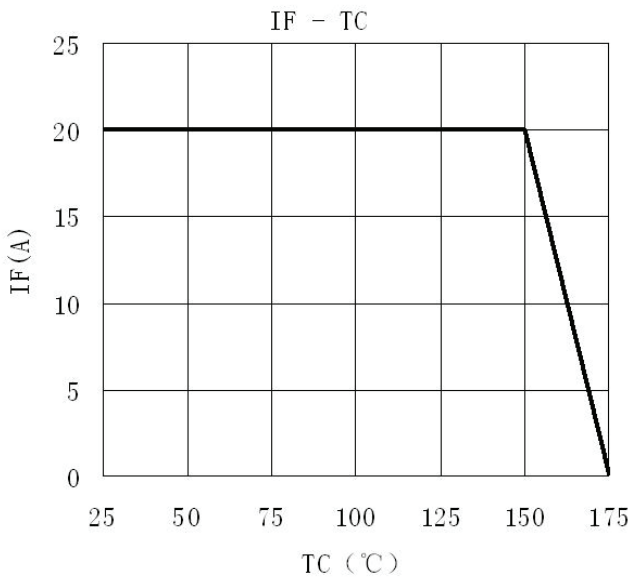
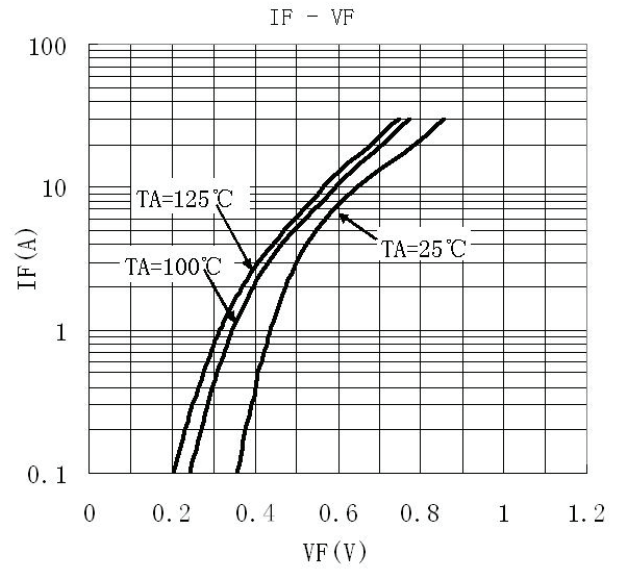
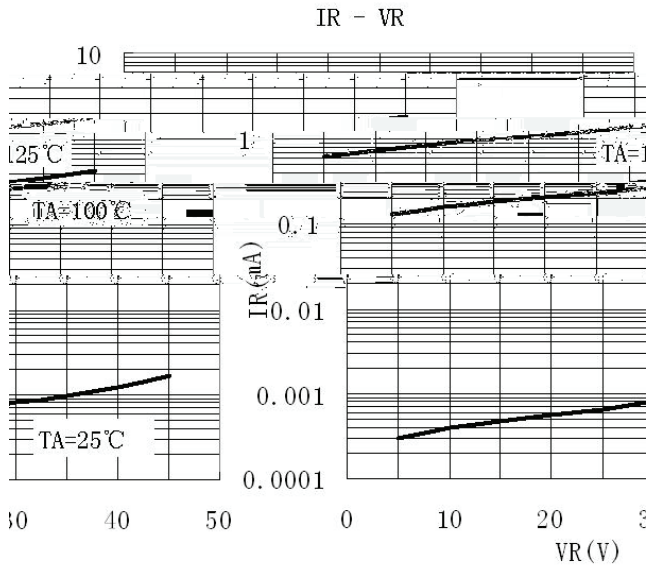


/ h_{FE} Classifications & Marking

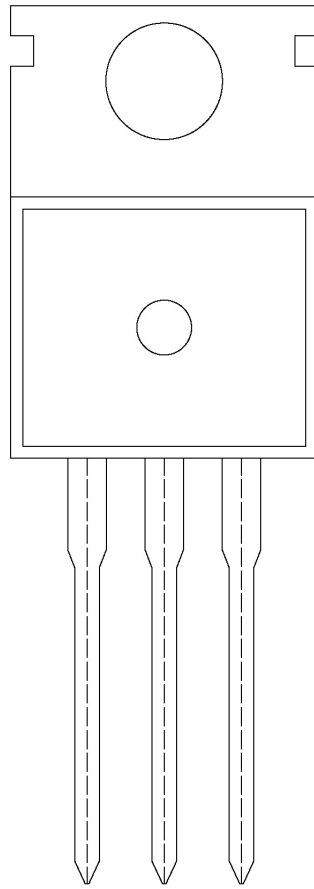
	θ		

--	--	--

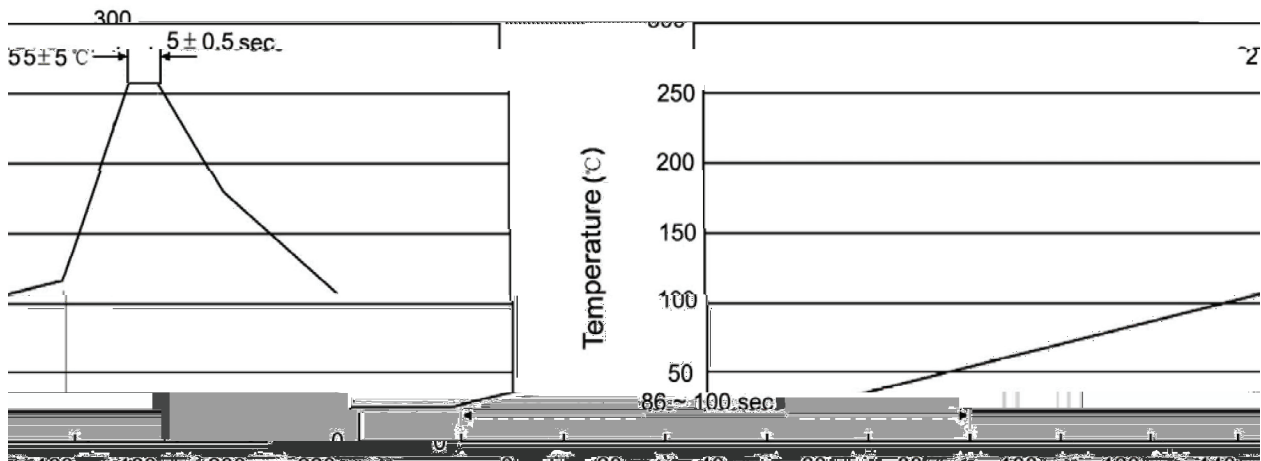
/ Electrical Characteristic Curve



/ Marking Instructions



() / Temperature Profile for Dip Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

封装形式	Units/Bag 只/袋	Bags/Inner Box 袋/盒	包装数量 Units/Inner Box 只/盒	包装尺寸 :
------	------------------	-----------------------	--------------------------------	--------